

POLYFET RF DEVICES

F3003

T.39.13

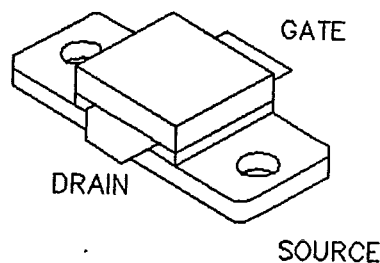
General Description

Silicon vertical DMOS designed specifically for RF applications. Immune to forward and reverse bias secondary breakdown. "POLYFET"™ process features gold metal for greatly extended lifetime. Low output capacitance and high F_t enhance broad band performance.

PATENTED GOLD METALIZED SILICON
RF POWER MOSFET

100 WATTS TO 175 MHZ

Single Ended
Package Style AU

ABSOLUTE MAXIMUM RATINGS ($T_C = 25\text{ }^\circ\text{C}$)

| Total Device Dissipation | Junction to Case Thermal Resistance | Maximum Junction Temperature | Storage Temperature | DC Drain Current | Drain to Gate Voltage | Drain to Source Voltage | Gate to Source Voltage |
|--------------------------|-------------------------------------|------------------------------|--|------------------|-----------------------|-------------------------|------------------------|
| 180 Watts | 1.00 $^\circ\text{C/W}$ | 200 $^\circ\text{C}$ | -65 $^\circ\text{C}$ to 150 $^\circ\text{C}$ | 10 A | 70 V | 70 V | 40 V |

RF CHARACTERISTICS (100 WATTS OUTPUT)

| SYMBOL | PARAMETER | MINIMUM | TYPICAL | MAXIMUM | UNITS | CONDITIONS |
|----------|--------------------------|---------|---------|---------|----------|---|
| G_{ps} | Common Source Power Gain | 13 | | | dB | $I_{DQ} = 1.0\text{A}$, $V_{DS} = 28\text{V}$, $F = 175\text{ MHz}$ |
| η | Drain Efficiency | | 60 | | % | $I_{DQ} = 1.0\text{A}$, $V_{DS} = 28\text{V}$, $F = 175\text{ MHz}$ |
| VSWR | Load Mismatch Tolerance | | | 20 : 1 | Relative | $I_{DQ} = 1.0\text{A}$, $V_{DS} = 28\text{V}$, $F = 175\text{ MHz}$ |

ELECTRICAL CHARACTERISTICS

| SYMBOL | PARAMETER | MINIMUM | TYPICAL | MAXIMUM | UNITS | CONDITIONS |
|------------|------------------------------------|---------|---------|---------|---------------|---|
| BV_{DSS} | Drain Breakdown Voltage | 65 | | | V | $I_D = 0.1\text{A}$, $V_{GS} = 0\text{V}$ |
| I_{DSS} | Zero Bias Drain Current | | | 6 | mA | $V_{DS} = 28\text{V}$, $V_{GS} = 0\text{V}$ |
| I_{GSS} | Gate Leakage Current | | | 1 | μA | $V_{DS} = 0\text{V}$, $V_{GS} = 40\text{V}$ |
| V_{GS} | Gate Bias for Drain Current | 1 | | 7 | V | $I_D = 0.3\text{A}$, $V_{GS} = V_{DS}$ |
| g_M | Forward Transconductance | | 3.5 | | MHO | $V_{DS} = 28\text{V}$, $I_D = 3.0\text{A}$, $F = 120\text{ Hz}$ |
| C_{iss} | Common Source Input Capacitance | | 200 | | pFD | $V_{DS} = 28\text{V}$, $V_{GS} = 0\text{V}$, $F = 1\text{ MHz}$ |
| C_{rss} | Common Source Feedback Capacitance | | 20 | | pFD | $V_{DS} = 28\text{V}$, $V_{GS} = 0\text{V}$, $F = 1\text{ MHz}$ |
| C_{oss} | Common Source Output Capacitance | | 120 | | pFD | $V_{DS} = 28\text{V}$, $V_{GS} = 0\text{V}$, $F = 1\text{ MHz}$ |

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